

## Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

[International Rectifier \(Infineon Technologies Americas Corp.\)  
IRF7342D2PBF](#)

For any questions, you can email us directly:

[sales@integrated-circuit.com](mailto:sales@integrated-circuit.com)

International  
**IR** Rectifier

PD- 95299

**IRF7342D2PbF**

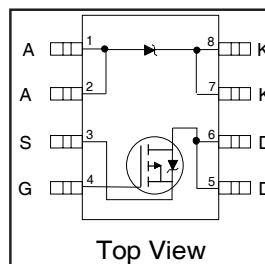
**FETKY™** MOSFET & Schottky Diode

- Co-packaged HEXFET® Power MOSFET and Schottky Diode
- Ideal For Buck Regulator Applications
- P-Channel HEXFET®
- Low  $V_F$  Schottky Rectifier
- SO-8 Footprint
- Lead-Free

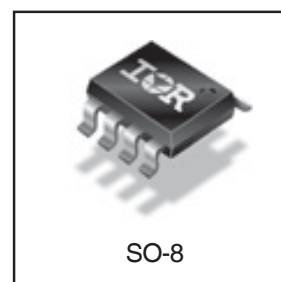
### Description

The **FETKY™** family of Co-packaged HEXFETs and Schottky diodes offer the designer an innovative board space saving solution for switching regulator and power management applications. HEXFETs utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. Combining this technology with International Rectifier's low forward drop Schottky rectifiers results in an extremely efficient device suitable for use in a wide variety of portable electronics applications.

The SO-8 has been modified through a customized leadframe for enhanced thermal characteristics. The SO-8 package is designed for vapor phase, infrared or wave soldering techniques.



|                           |
|---------------------------|
| $V_{DSS} = -55V$          |
| $R_{DS(on)} = 105m\Omega$ |
| Schottky $V_f = 0.61V$    |



### Absolute Maximum Ratings ( $T_A = 25^\circ C$ Unless Otherwise Noted)

| Parameter                  | Maximum     | Units |
|----------------------------|-------------|-------|
| $I_D$ @ $T_A = 25^\circ C$ | -3.4        | A     |
| $I_D$ @ $T_A = 70^\circ C$ | -2.7        | A     |
| $I_{DM}$                   | -27         | A     |
| $P_D$ @ $T_A = 25^\circ C$ | 2.0         | W     |
| $P_D$ @ $T_A = 70^\circ C$ | 1.3         | W     |
|                            | 16          | mW/°C |
| $V_{GS}$                   | $\pm 20$    | V     |
| $dv/dt$                    | -5.0        | V/ns  |
| $T_J, T_{STG}$             | -55 to +150 | °C    |

### Thermal Resistance

| Symbol          | Parameter                       | Typ. | Max. | Units |
|-----------------|---------------------------------|------|------|-------|
| $R_{\theta JL}$ | Junction-to-Drain Lead, MOSFET  | —    | 20   | °C/W  |
| $R_{\theta JA}$ | Junction-to-Ambient ④, MOSFET   | —    | 62.5 | °C/W  |
| $R_{\theta JA}$ | Junction-to-Ambient ④, SCHOTTKY | —    | 62.5 | °C/W  |

### Notes:

① Repetitive rating – pulse width limited by max. junction temperature (see fig. 11)

②  $I_{SD} \leq -3.4A$ ,  $di/dt \leq -150A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq 150^\circ C$

③ Pulse width  $\leq 400\mu s$  – duty cycle  $\leq 2\%$

④ Surface mounted on 1 inch square copper board,  $t \leq 10sec$ .

www.irf.com

# IRF7342D2PbF

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

International  
**IR** Rectifier

|                                 | Parameter                            | Min. | Typ.   | Max. | Units               | Conditions                                           |
|---------------------------------|--------------------------------------|------|--------|------|---------------------|------------------------------------------------------|
| $V_{(BR)DSS}$                   | Drain-to-Source Breakdown Voltage    | -55  | —      | —    | V                   | $V_{GS} = 0V, I_D = -250\mu A$                       |
| $\Delta V_{(BR)DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient  | —    | -0.054 | —    | V/ $^\circ\text{C}$ | Reference to $25^\circ\text{C}$ , $I_D = -1mA$       |
| $R_{DS(on)}$                    | Static Drain-to-Source On-Resistance | —    | 95     | 105  | m $\Omega$          | $V_{GS} = -10V, I_D = -3.4A$ ③                       |
|                                 |                                      | —    | 150    | 170  |                     | $V_{GS} = -4.5V, I_D = -2.7A$ ③                      |
| $V_{GS(th)}$                    | Gate Threshold Voltage               | -1.0 | —      | —    | V                   | $V_{DS} = V_{GS}, I_D = -250\mu A$                   |
| $g_{fs}$                        | Forward Transconductance             | 3.3  | —      | —    | S                   | $V_{DS} = -10V, I_D = -3.1A$                         |
| $I_{DSS}$                       | Drain-to-Source Leakage Current      | —    | —      | -2.0 | $\mu A$             | $V_{DS} = -44V, V_{GS} = 0V$                         |
|                                 |                                      | —    | —      | -25  |                     | $V_{DS} = -44V, V_{GS} = 0V, T_J = 70^\circ\text{C}$ |
| $I_{GSS}$                       | Gate-to-Source Forward Leakage       | —    | —      | -100 | nA                  | $V_{GS} = -20V$                                      |
|                                 | Gate-to-Source Reverse Leakage       | —    | —      | 100  |                     | $V_{GS} = 20V$                                       |
| $Q_g$                           | Total Gate Charge                    | —    | 26     | 38   | nC                  | $I_D = -3.1A$                                        |
| $Q_{gs}$                        | Gate-to-Source Charge                | —    | 3.0    | 4.5  |                     | $V_{DS} = -44V$                                      |
| $Q_{gd}$                        | Gate-to-Drain ("Miller") Charge      | —    | 8.4    | 13   |                     | $V_{GS} = -10V$ , See Fig. 6 & 14 ③                  |
| $t_{d(on)}$                     | Turn-On Delay Time                   | —    | 14     | 22   | ns                  | $V_{DD} = -28V$                                      |
| $t_r$                           | Rise Time                            | —    | 10     | 15   |                     | $I_D = -1.0A$                                        |
| $t_{d(off)}$                    | Turn-Off Delay Time                  | —    | 43     | 64   |                     | $R_G = 6.0\Omega$                                    |
| $t_f$                           | Fall Time                            | —    | 22     | 32   |                     | $V_{GS} = -10V$ , ③                                  |
| $C_{iss}$                       | Input Capacitance                    | —    | 690    | —    | pF                  | $V_{GS} = 0V$                                        |
| $C_{oss}$                       | Output Capacitance                   | —    | 210    | —    |                     | $V_{DS} = -25V$                                      |
| $C_{rss}$                       | Reverse Transfer Capacitance         | —    | 86     | —    |                     | $f = 1.0MHz$ , See Fig. 5                            |

## MOSFET Source-Drain Ratings and Characteristics

|          | Parameter                              | Min. | Typ. | Max. | Units | Conditions                                         |
|----------|----------------------------------------|------|------|------|-------|----------------------------------------------------|
| $I_S$    | Continuous Source Current (Body Diode) | —    | —    | -2.0 | A     | $T_J = 25^\circ\text{C}, I_S = -2.0A, V_{GS} = 0V$ |
| $I_{SM}$ | Pulsed Source Current (Body Diode)     | —    | —    | -27  |       |                                                    |
| $V_{SD}$ | Body Diode Forward Voltage             | —    | —    | -1.2 | V     | $T_J = 25^\circ\text{C}, I_S = -2.0A, V_{GS} = 0V$ |
| $t_{rr}$ | Reverse Recovery Time (Body Diode)     | —    | 54   | 80   | ns    | $T_J = 25^\circ\text{C}, I_F = -2.0A$              |
| $Q_{rr}$ | Reverse Recovery Charge                | —    | 85   | 130  | nC    | $di/dt = 100A/\mu s$ ③                             |

## Schottky Diode Maximum Ratings

|            | Parameter                                        | Max. | Units | Conditions                                                                |
|------------|--------------------------------------------------|------|-------|---------------------------------------------------------------------------|
| $I_f$ (av) | Max. Average Forward Current                     | 3.0  | A     | 50% Duty Cycle. Rectangular Wave, $T_A = 57^\circ\text{C}$<br>See Fig. 21 |
| $I_{SM}$   | Max. peak one cycle Non-repetitive Surge current | 490  | A     | 5 $\mu s$ sine or 3 $\mu s$ Rect. pulse                                   |
|            |                                                  | 70   |       | 10ms sine or 6ms Rect. pulse                                              |

Following any rated load condition & with  $V_{rrm}$  applied

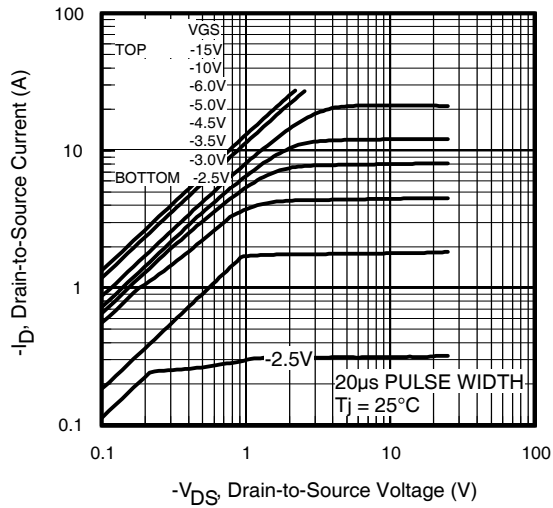
## Schottky Diode Electrical Specifications

|           | Parameter                         | Max. | Units | Conditions                                            |
|-----------|-----------------------------------|------|-------|-------------------------------------------------------|
| $V_{fm}$  | Max. Forward Voltage Drop         | 0.61 | V     | $I_f = 3.0A, T_J = 25^\circ\text{C}$                  |
|           |                                   | 0.76 |       | $I_f = 6.0A, T_J = 25^\circ\text{C}$                  |
|           |                                   | 0.53 |       | $I_f = 3.0A, T_J = 125^\circ\text{C}$                 |
|           |                                   | 0.65 |       | $I_f = 6.0A, T_J = 125^\circ\text{C}$                 |
| $V_{rrm}$ | Max. Working Peak Reverse Voltage | 60   | V     |                                                       |
| $I_{rm}$  | Max. Reverse Leakage Current      | 2.0  | mA    | $V_r = 60V, T_J = 25^\circ\text{C}$                   |
|           |                                   | 30   |       | $T_J = 125^\circ\text{C}$                             |
| $C_t$     | Max. Junction Capacitance         | 145  | pF    | $V_r = 5V_{dc}$ ( 100kHz to 1 MHz) $25^\circ\text{C}$ |

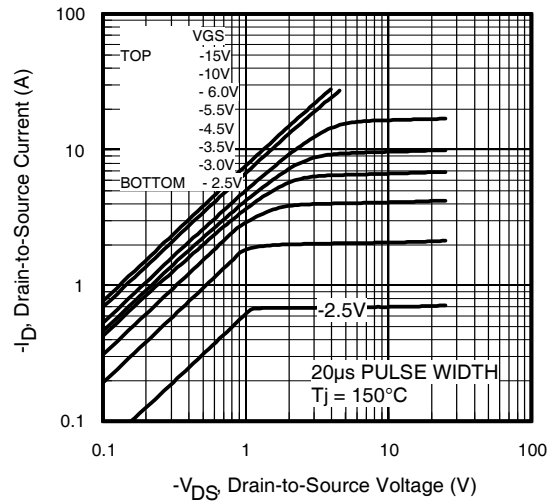
International  
**IR** Rectifier

## IRF7342D2PbF

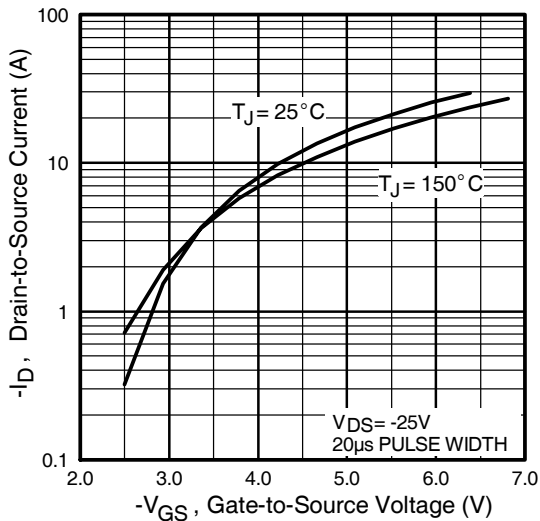
### Power Mosfet Characteristics



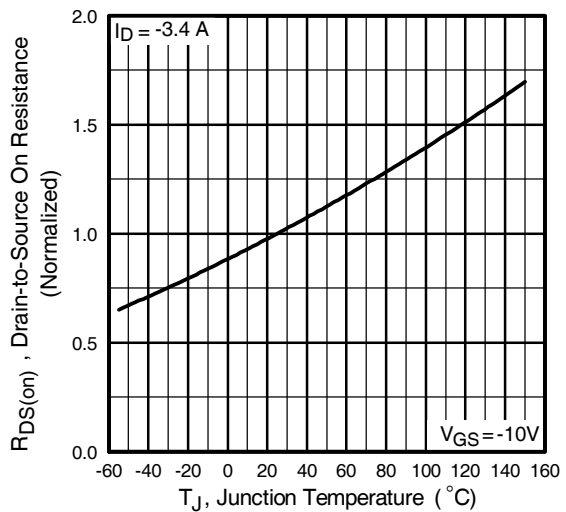
**Fig 1.** Typical Output Characteristics



**Fig 2.** Typical Output Characteristics



**Fig 3.** Typical Transfer Characteristics

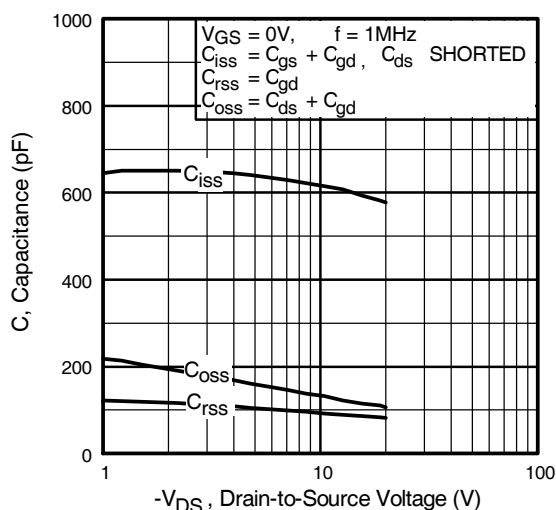


**Fig 4.** Normalized On-Resistance Vs. Temperature

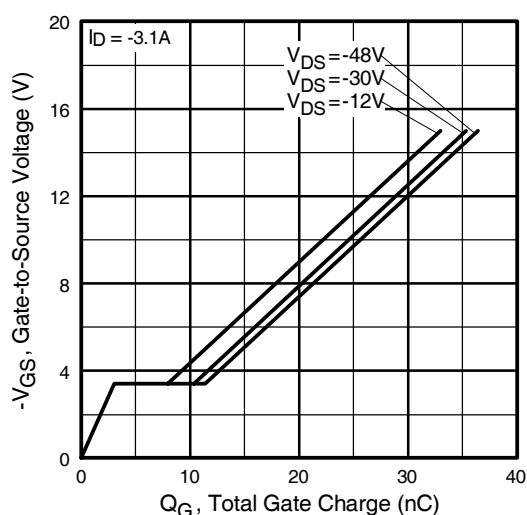
# IRF7342D2PbF

International  
**IR** Rectifier

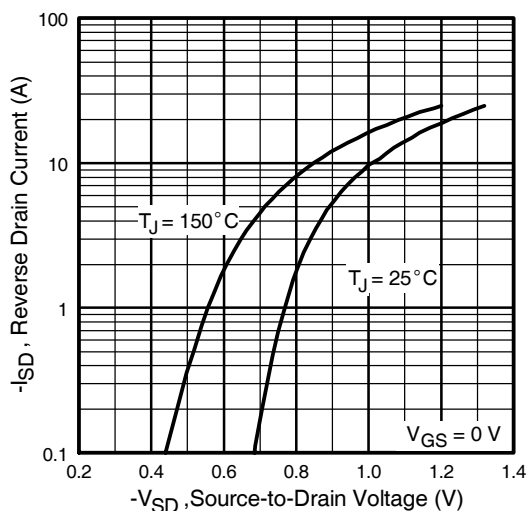
## Power Mosfet Characteristics



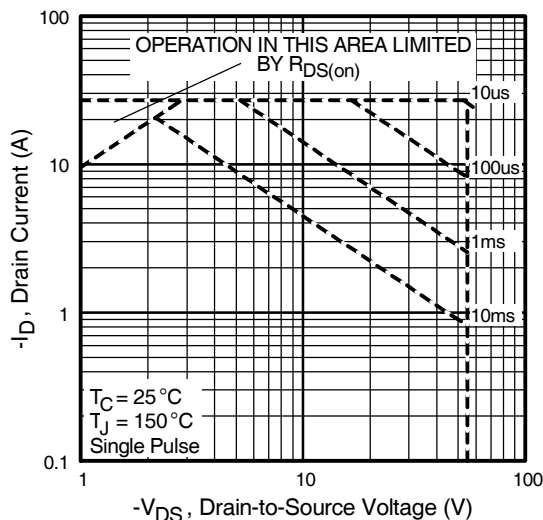
**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



**Fig 7.** Typical Source-Drain Diode Forward Voltage

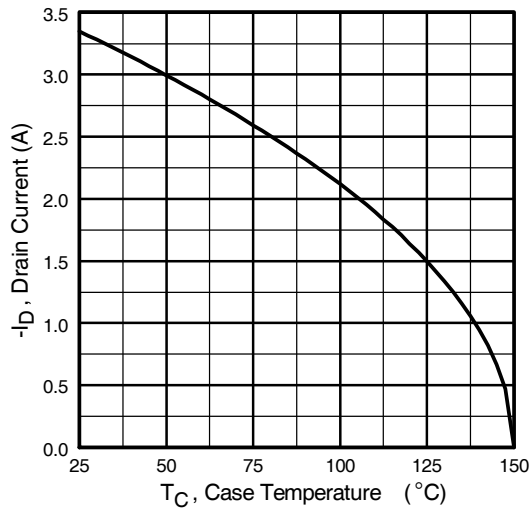


**Fig 8.** Maximum Safe Operating Area

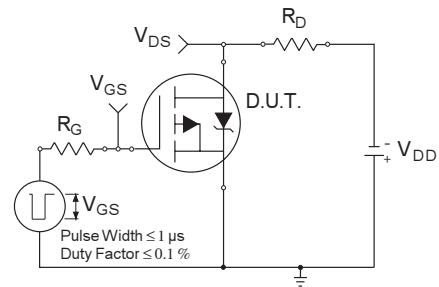
International  
**IR** Rectifier

## IRF7342D2PbF

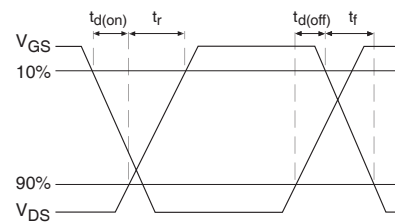
### Power Mosfet Characteristics



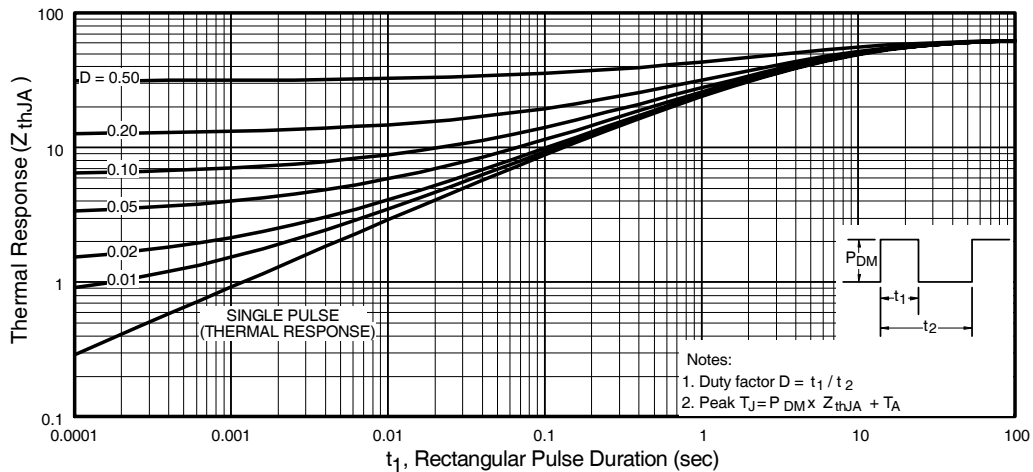
**Fig 9.** Maximum Drain Current Vs. Case Temperature



**Fig 10a.** Switching Time Test Circuit



**Fig 10b.** Switching Time Waveforms

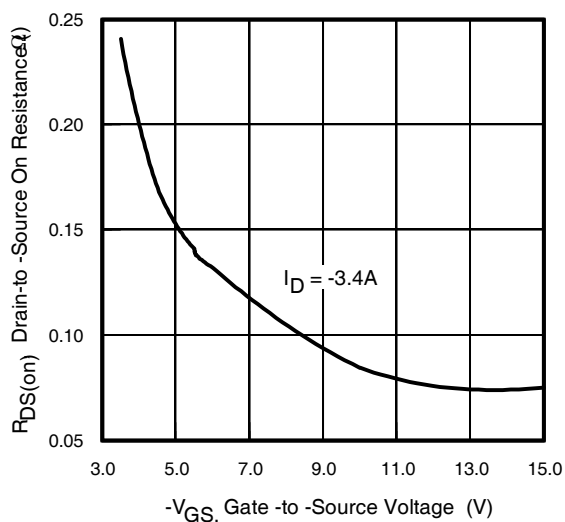


**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

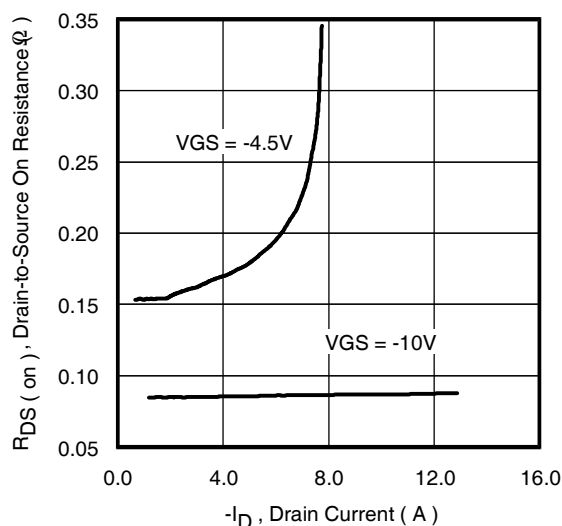
# IRF7342D2PbF

International  
**IR** Rectifier

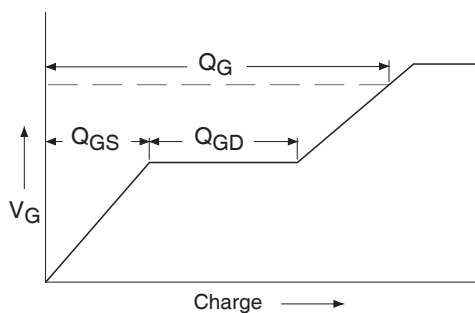
## Power Mosfet Characteristics



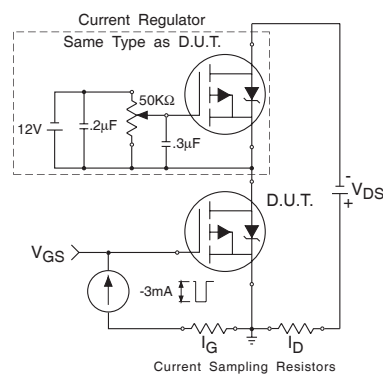
**Fig 12.** Typical On-Resistance Vs. Gate Voltage



**Fig 13.** Typical On-Resistance Vs. Drain Current



**Fig 14a.** Basic Gate Charge Waveform

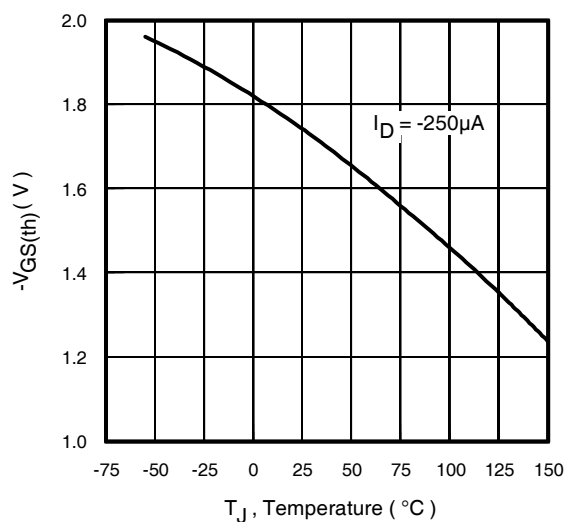


**Fig 14b.** Gate Charge Test Circuit  
www.irf.com

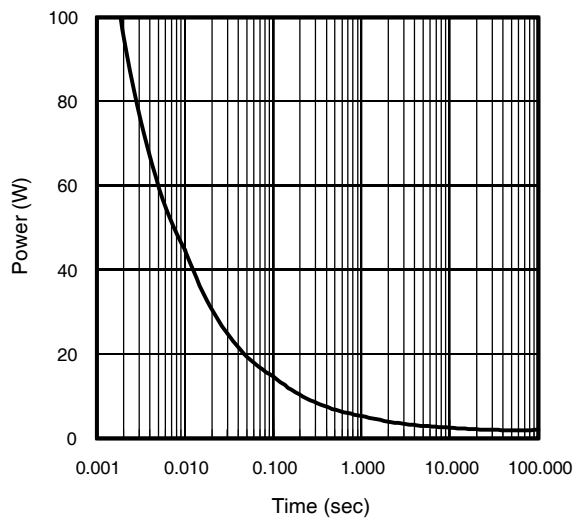
International  
**IR** Rectifier

## IRF7342D2PbF

### Power Mosfet Characteristics



**Fig 15.** Typical  $V_{GS(th)}$  Vs. Junction Temperature

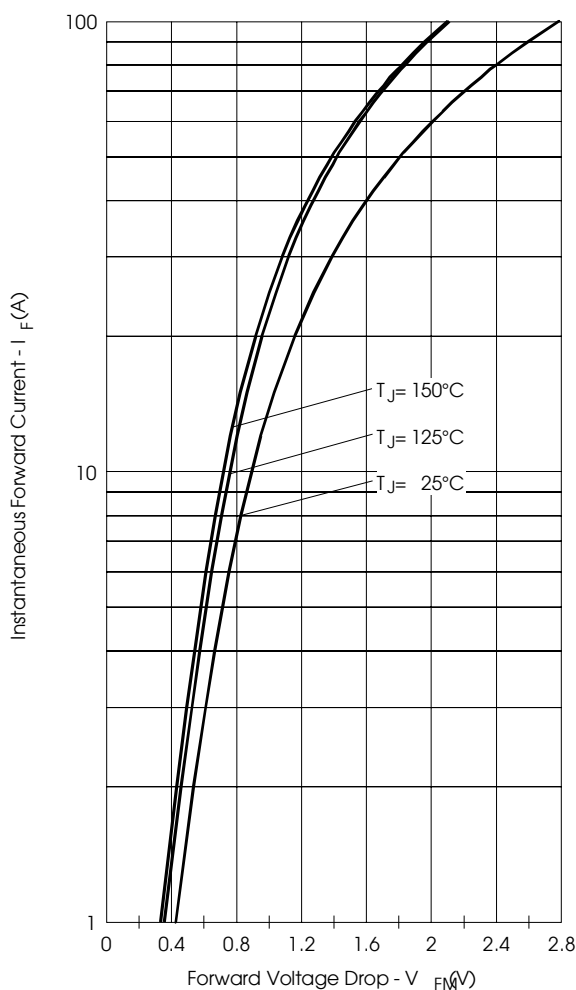


**Fig 16.** Typical Power Vs. Time

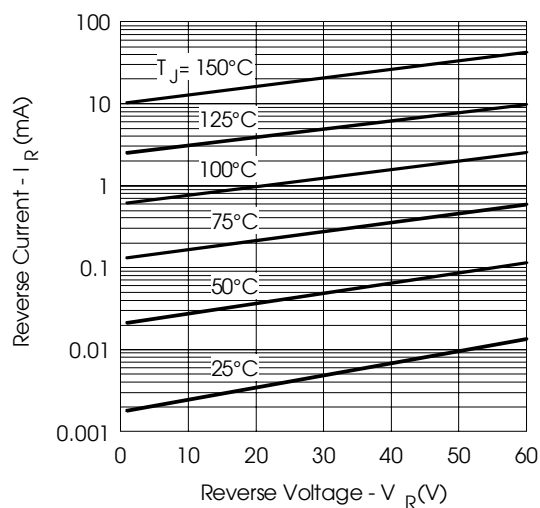
# IRF7342D2PbF

International  
**IR** Rectifier

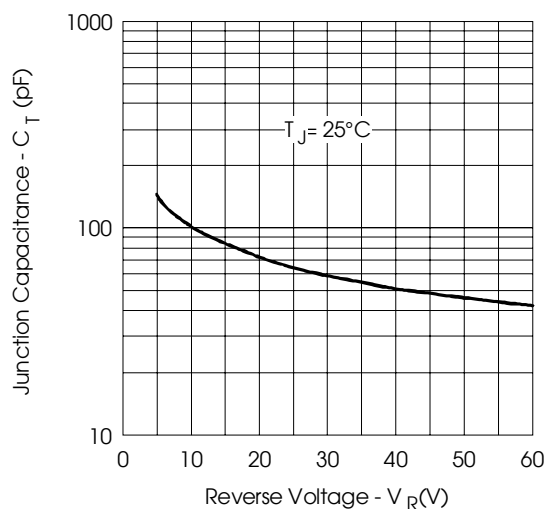
## Schottky Diode Characteristics



**Fig. 17 - Maximum Forward Voltage Drop Characteristics**



**Fig. 18 - Typical Values of Reverse Current Vs. Reverse Voltage**

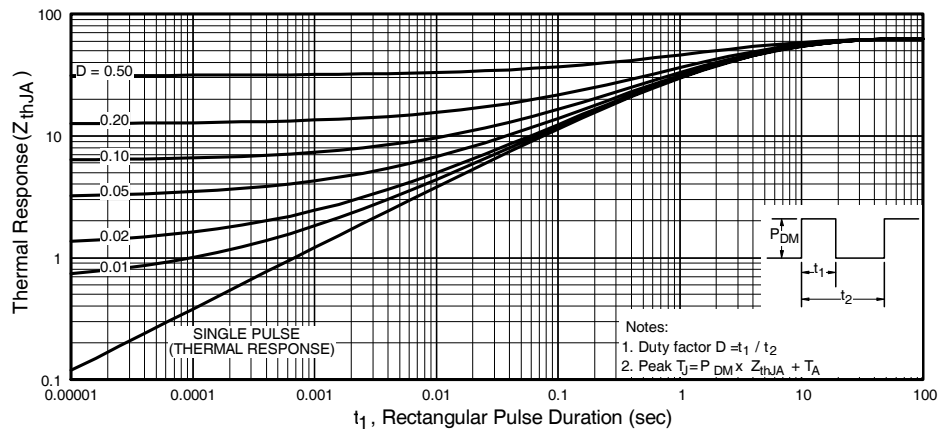


**Fig. 19 - Typical Junction Capacitance Vs. Reverse Voltage**

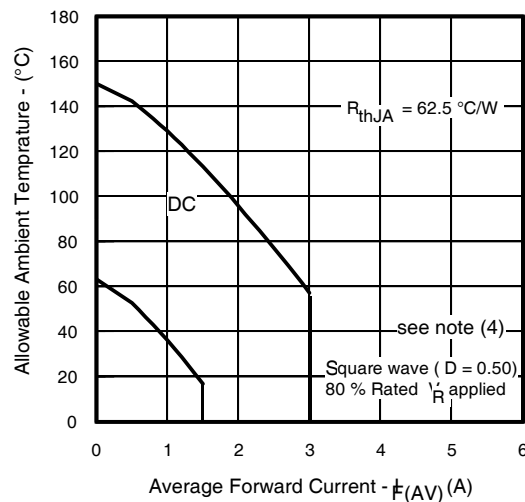
International  
**IR** Rectifier

**IRF7342D2PbF**

### Schottky Diode Characteristics



**Fig 20.** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



**Fig.21** - Maximum Allowable Ambient Temp. Vs. Forward Current

**Note(4)** Formula used:  $T_C = T_J - (P_d + P_{d_{REV}}) \times R_{thJA}$ ;

$P_d$  = Forward Power Loss =  $I_{F(AV)} \times V_{FM} @ (I_{F(AV)} / D)$  ;

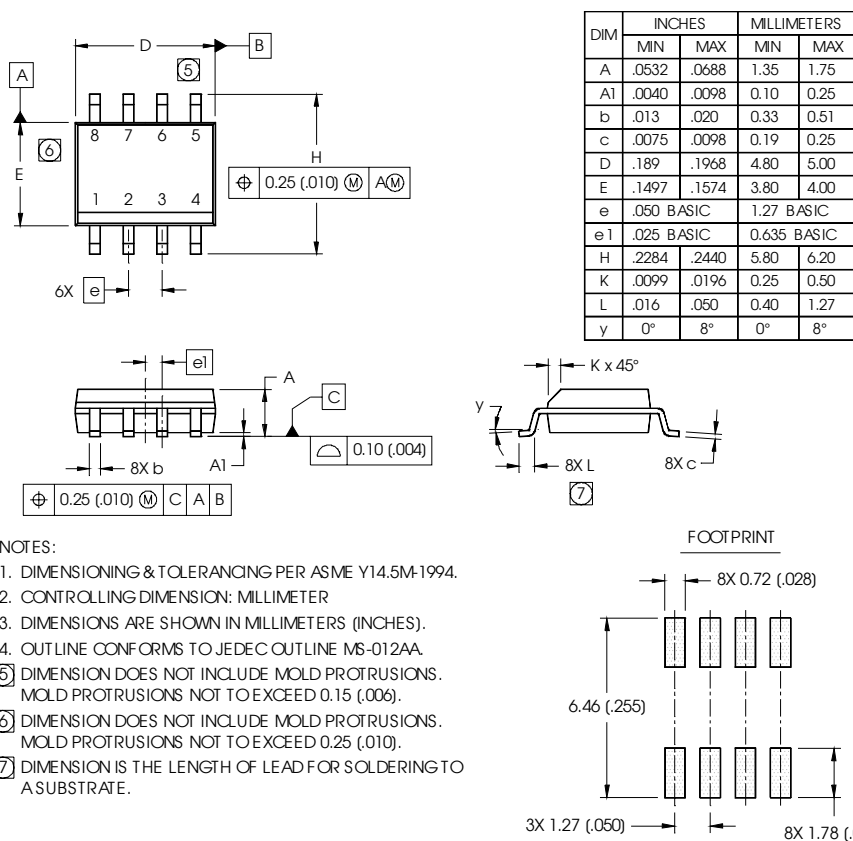
$P_{d_{REV}}$  = Inverse Power Loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R @ V_{R1} = 80\% \text{ rated } V_R$

www.irf.com

# IRF7342D2PbF

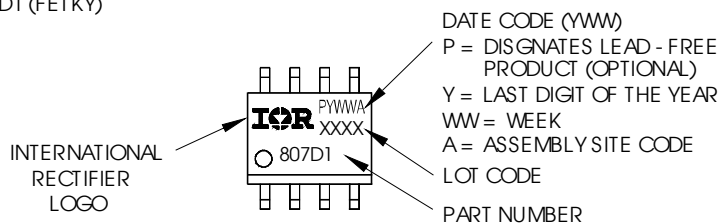
International  
**IR** Rectifier

## SO-8 (Fetky) Package Outline



## SO-8 (Fetky) Part Marking Information

EXAMPLE: THIS IS AN IRF7807D1 (FETKY)

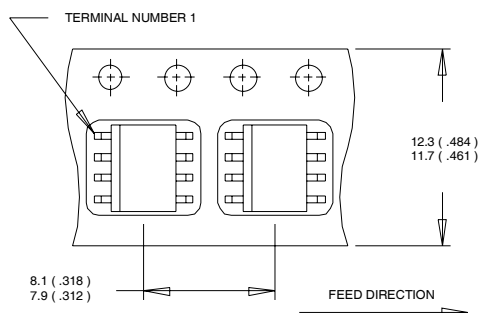


International  
**IR** Rectifier

## IRF7342D2PbF

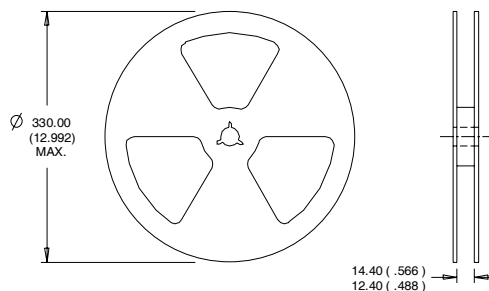
### SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



**NOTES:**

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



**NOTES :**

1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Data and specifications subject to change without notice.  
This product has been designed and qualified for the Consumer market.  
Qualification Standards can be found on IR's Web site.

International  
**IR** Rectifier

**IR WORLD HEADQUARTERS:** 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105  
TAC Fax: (310) 252-7903

Visit us at [www.irf.com](http://www.irf.com) for sales contact information.10/04